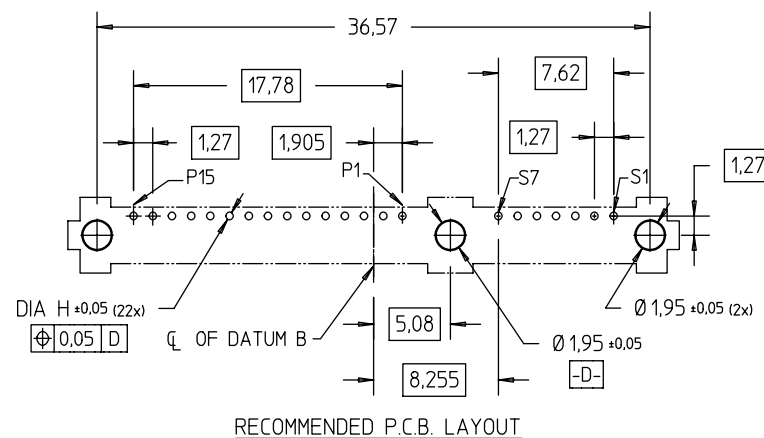
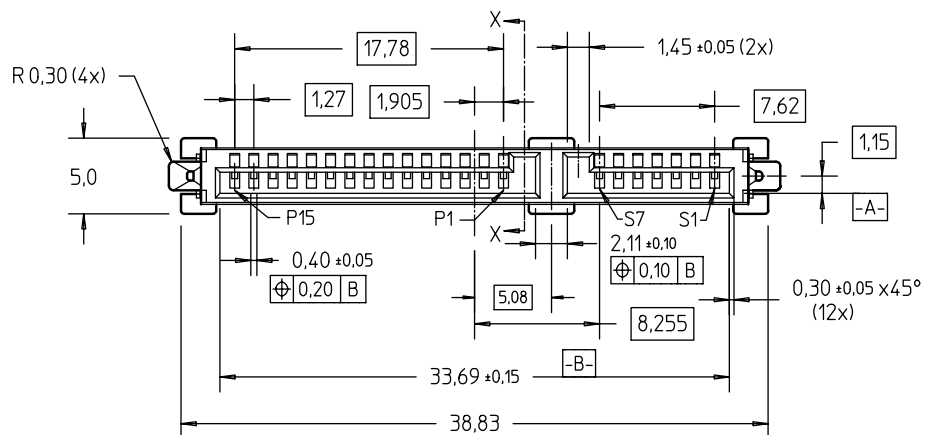


PRODUCT NO	DIM L	RECOMMENDED P.C. BOARD THICKNESS	DIA "H"
10017660-001LF	2.70	1,57mm (0,062") / 2,36mm (0,093")	0,50
10017660-011LF	3.70	2,36mm (0,093")	0,50



SEC X-X

NOTES:

1 MATERIAL:

- 1) HOUSING : HIGH TEMP. THERMOPLASTIC, UL 94V-0
COLOR : BLACK

- 2) TERMINAL : COPPER ALLOY
3) HOLD DOWN : COPPER ALLOY

2 FINISH :

- 1) TERMINAL : 30u" Au PLATING (CONTACT POINT) OVER 50u" MIN NICKEL
2) SOLDER TAIL : 100u" MIN TIN OVER 50u" MIN NICKEL
3) HOLD DOWN : 100u" MIN TIN OVER 50u" MIN NICKEL

3 TRUE POSITION NOTES APPLY AT TERMINAL TIP

4 PER S-ATA SPEC REV 1.0a

mat'l. code				surface ISO 1302 ✓		tolerance ISO 406 ISO 1101		projection 		product family S-ATA											
ltr		ecn no		dr		date		tolerances unless otherwise specified				title									
A		S04-0131		GLL		2004-10-05		angles		linear		= ±0,20				S-ATA COMB RECEP. VERTICAL TH TYPE ASSY					
B		S05-0035		GLL		2005-02-07															
C		S06-0312		GLL		2006-09-19		± 2°				scale 2 : 1									
D		S09-0179		GLL		2009-05-28		dr		GL L00		2004-10-05		dwg no 10017660							
								enrg		GL L00		2004-10-05				FCI 					
								chr		GL L00		2009-05-28									
								appd		JOEY NG		2009-05-28									
sheet index		revision sheet		D		D										type		CUSTOMER		Drawing	
				1		2															

